

Product Summary (@TA = +25°C)

VBR (MIN)	IPP (MAX)	Vc (MAX)
5.2V	28.2A	8.0V

Description

This new generation TVS is designed for transient overvoltage protection. The combination of small size and high ESD surge capability makes it ideal for use in power management and battery contact.

Applications

It is ideally suited for use in applications such as the following:

- Power Management
- Battery Contacts

Features

- 225W Peak Pulse Power Dissipation (10µs × 1000µs Waveform)
- 3.3V Standoff Voltage
- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±30kV, Contact ±30kV
- Excellent Clamping Capability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Case: SOD123F
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Matte Tin Finish Annealed over Copper Alloy Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.018 grams (Approximate)

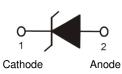


Top View



SOD123F (Type B)

Bottom View



Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D3V3AP2WF-7	Commercial	P2A	7	8	3,000/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



P2A = Product Type Marking Code YM = Date Code Marking Y = Year (ex: G = 2019) M = Month (ex: 9 = September) Bar Denotes Cathode Side

Date Code Key

Date Code Rey												
Year	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	G	Н		J	K	L	М	N	0	Р	R	S
									•	<u> </u>		
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Pulse Power Dissipation (Note 5) 10/1000μs 8/20μs	Ррк	225 1125	w
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 6)	IFSM	35	A

Thermal Characteristics

Notes:

Characteristic	Symbol	Value	Unit
DC Steady-State Power Dissipation (Note 7)	PD	1.0	W
Thermal Resistance, Junction to Ambient (Note 7)	Reja	330	°C/W
Thermal Resistance, Junction to Soldering Point (Note 8)	Rejs	70	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

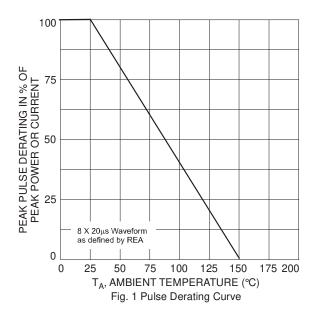
Part Number	Part Number Reverse Voltage		Breakdown Voltage V _{BR} @ Ιτ (Note 9)		Maximum Reverse Leakage @ V _{RWM}	Maximum Clamping Voltage @ IPP	Maximum Peak Pulse Current (Note 5)	Marking Code
	V _{RWM} (V)	Min (V)	Max (V)	I _T (mA)	Ι _R (μΑ)	Vc (V)	IPP (A)	
D3V3AP2WF-7	3.3	5.2	6.0	10	1000	8.0	28.2	P2A

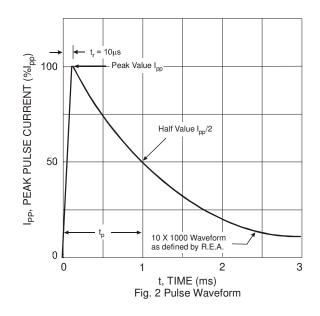
5. Non-Repetitive current pulse as shown in Figure 2.

6. 1/2 sine wave (or equivalent square wave), pulse width = 8.3ms, duty cycle = 4 pulses/minute maximum.
7. Device mounted on 1" × 1", FR-4 PCB; 2 oz. Cu pad layout.

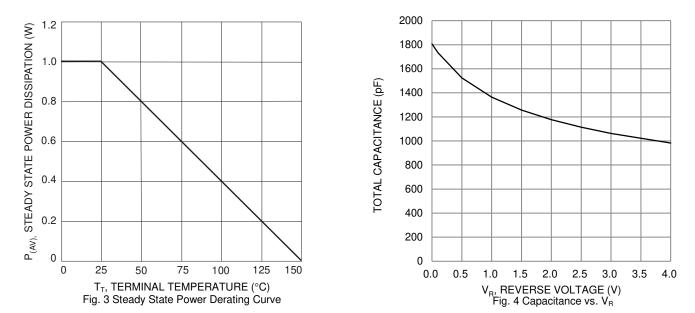
8. Theoretical $R_{\theta,JS}$ calculated from the top center of the die straight down to the PCB/cathode tab solder junction.

9. V_{BR} measured at pulse test current I_T with $t_p \leq 5.0ms$ at T_A = +25°C.





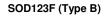


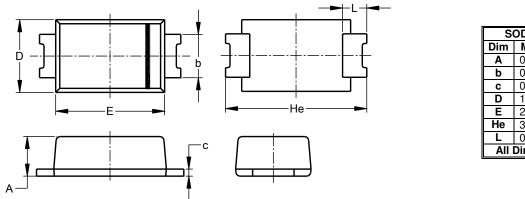




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

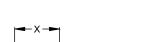




SOD123F (Type B)							
Dim Min Max Typ							
Α	0.81	1.15					
b	0.80	1.35					
С	0.05	0.30					
D	1.70	1.90	1.80				
Е	2.60	2.80	2.70				
He	3.30	3.70	3.50				
L	0.35	0.85					
All	Dimen	sions i	in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
G	1.90
Х	1.00
X1	3.90
Y	1.50

SOD123F (Type B)

G



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